



<b>Form Type</b>	Distribute	<b>Version</b>	2.0	<b>Ref</b>	IPC 1752A	<b>Sectionals</b>	Manufacturing Info/ Material Info	<b>Subsectionals</b>	D, A
<b>Supplier Information</b>									
<b>Company Name</b>	TE Connectivity	<b>Request Document ID</b>		<b>Contact Name</b>	Penica, John R	<b>Contact Title</b>	Sr Mgr Environmental Engineering, Ind Central Eng		
<b>Company Unique ID</b>	TE Connectivity	<b>Response Date</b>	2015-10-08	<b>Contact Email</b>	jrpenica@te.com				
<b>Contact Phone Number</b>	+1-717-592-3266								
<b>Legal Statement</b>									
<b>Supplier Acceptance</b>	true								
<b>Legal Statement</b>									
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.									
<b>Product</b>									
<b>Manufacturer Item number</b>	292175-5	<b>Amount</b>	524.859715	<b>Version</b>	-	<b>Identity</b>			
<b>Manufacturer Item Name</b>	CT BOX HDR V SMT 5P O/TAPE NAT	<b>Weight Uom</b>	mg	<b>Mfr Site</b>		<b>Authority</b>			
<b>Date</b>		<b>UOM</b>	Each						
<b>EUROHS-0508</b>	Product(s) meets EU RoHS requirement without any exemptions								
<b>ChinaRoHS-0508</b>	Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products								
<b>EUREACH-1214</b>	REACH Candidate Substances of Very High Concern ARE NOT Yet Reviewed								
<b>Manufacturing Information</b>									
<b>J-STD-020 MSL Rating</b>		<b>Max Total a Wave Time</b>		<b>Ramp Rate</b>		<b>Wave Additional Info</b>			
<b>Classification Temp</b>		<b>Max Wave Solder Time</b>	0.0	<b>Ramp Down Rate</b>		<b>Psi Rating Reflow</b>			
<b>Max Time Within 5</b>		<b>Psi Rating Wave</b>		<b>Package Designator</b>		<b>Size</b>	0.0		
<b>Time Above 217</b>		<b>Reflow Additional Info</b>		<b>Preheat Max Temp</b>		<b>Terminal Base Alloy</b>	NAC		
<b>Preheat Duration</b>		<b>bulk Solder Termination</b>	NAC	<b>Nbr or Reflow Cycles</b>		<b>Terminal Plating</b>	NAC		
<b>Preheat Min Temp</b>		<b>Nbr of Instances</b>	0	<b>Component Temp Spike</b>		<b>Shape</b>	NAC		
<b>Product Disclosure</b>									
<b>Sub-Item/Material/Substance</b>	<b>Level</b>	<b>Name</b>	<b>Substance Category</b>	<b>Substance CAS</b>	<b>Substance Concentration</b>	<b>Quantity</b>	<b>Mass per Unit</b>	<b>UOM</b>	<b>Exemption</b>
Sub-Item	1	TAIL PLATE FOR CT SMT				2.0	25.0	mg	
Material	2	Tin Plate				2.0	0.855803	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	2.0	8.558E-4	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.4	2.0	0.00342321	mg	
Substance	3	Tin	Supplier	7440-31-5	99.5	2.0	0.85152	mg	
Material	2	Brass				2.0	23.935287	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.0010	2.0	2.3935E-4	mg	
Substance	3	Zinc	Supplier	7440-66-6	28.0225	2.0	6.70727	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.05	2.0	0.01196764	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	2.0	0.00239353	mg	
Substance	3	Iron	Supplier	7439-89-6	0.05	2.0	0.01196764	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	2.0	0.02393529	mg	
Substance	3	Copper	Supplier	7440-50-8	71.5	2.0	17.11373	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	2.0	2.3935E-4	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.01	2.0	0.00239353	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	2.0	1.1968E-4	mg	
Substance	3	Nickel	Nickel	7440-02-0	0.2	2.0	0.04787057	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.0050	2.0	0.00119676	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.05	2.0	0.01196764	mg	
Material	2	Nickel Plate				2.0	0.20891	mg	

Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	2.0	4.1782E-4	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	2.0	2.0891E-4	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	2.0	0.20828	mg	
Sub-Item	1	HEADER HOUSING SMT-TYPE CT 2MM PITCH W/O				1.0	344.0	mg	
Material	2	PPA-GF30				1.0	344.0	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.0020	1.0	0.00688	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0909	2.0	1.0	6.88	mg	
Substance	3	Antimonate (SbO31-), sodium (1:1)	Supplier	15432-85-6	2.0	1.0	6.88	mg	
Substance	3	Glass, oxide, chemicals	Supplier	65997-17-3	23.9959	1.0	82.5459	mg	
Substance	3	1,4-Benzenedicarboxylic acid, polymer with 1,6-hexanediamine and hexanedioic acid	Supplier	25776-72-1	44.3	1.0	152.392	mg	
Substance	3	Talc (Mg3H2(SiO3)4)	Supplier	14807-96-6	0.7	1.0	2.408	mg	
Substance	3	Magnesium oxide (MgO)	Supplier	1309-48-4	6.0	1.0	20.64	mg	
Substance	3	Benzene, ethenyl-, homopolymer, brominated	Supplier	88497-56-7	21.0	1.0	72.24	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	1.0E-4	1.0	3.44E-4	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.0020	1.0	0.00688	mg	
Sub-Item	1	0.6DIA POST				5.0	26.171943	mg	
Material	2	Brass				5.0	25.398021	mg	
Substance	3	Nickel	Nickel	7440-02-0	0.2	5.0	0.05079604	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	5.0	0.0025398	mg	
Substance	3	Zinc	Supplier	7440-66-6	35.4675	5.0	9.00804	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	5.0	0.02539802	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.0010	5.0	2.5398E-4	mg	
Substance	3	Iron	Supplier	7439-89-6	0.05	5.0	0.01269901	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.05	5.0	0.01269901	mg	
Substance	3	Copper	Supplier	7440-50-8	64.0	5.0	16.25473	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	5.0	2.5398E-4	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.01	5.0	0.0025398	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	5.0	0.02539802	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	5.0	1.2699E-4	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.01	5.0	0.0025398	mg	
Material	2	Nickel Plate				5.0	0.412137	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	5.0	8.2427E-4	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	5.0	4.1214E-4	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	5.0	0.4109	mg	
Material	2	Tin Plate				5.0	0.361785	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.4	5.0	0.00144714	mg	
Substance	3	Tin	Supplier	7440-31-5	99.5	5.0	0.35998	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	5.0	3.6178E-4	mg	